

FM820-T THRU FM840-T

Silicon epitaxial planer type

Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-O Utilizing Flame Retardant Epoxy Molding Compound.
- For surface mounted applications.
- Exceeds environmental standards of ML-S-19500 / 228
- Low leakage current

Mechanical data

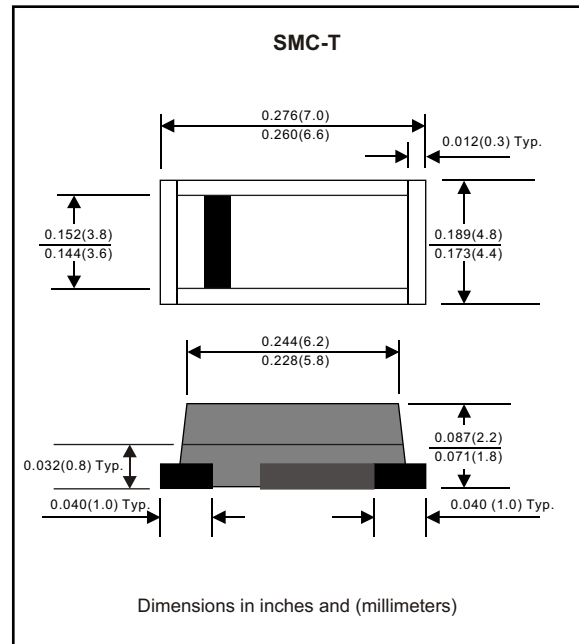
Case : Moulded plastic, JEDEC DO-214AB

Terminals : Solder plated, solderable per ML-STD-750, Method 2026

Polarity : Indicated by cathode band

Mounting Position : Any

Weight : 0.00585 ounce, 0.195 gram



MAXIMUM RATINGS (AT $T_A=25^{\circ}C$ unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.1	I_O			8.0	A
Forward surge current	8.3ms single half sine-wave superimposed on rate load (JEDEC methode)	I_{FSM}			150	A
Reverse current	$V_R = V_{RRM} T_A = 25^{\circ}C$	I_R			5.0	mA
	$V_R = V_{RRM} T_A = 100^{\circ}C$				50	mA
Thermal resistance	Junction to ambient	R_{JA}		55		$^{\circ}C / w$
Diode junction capacitance	$f=1MHz$ and applied 4vDC reverse voltage	C_J		700		pF
Storage temperature		T_{STG}	-55		+150	$^{\circ}C$

SYMBOLS	MARKING CODE	V_{RRM}^{*1} (V)	V_{RMS}^{*2} (V)	V_R^{*3} (V)	V_F^{*4} (V)	Operating temperature ($^{\circ}C$)
FM820-T	SS82	20	14	20	0.65	-55 to +125
FM830-T	SS83	30	21	30		
FM840-T	SS84	40	28	40		

*1 Repetitive peak reverse voltage

*2 RMS voltage

*3 Continuous reverse voltage

*4 Maximum forward voltage

RATING AND CHARACTERISTIC CURVES (FM820-T THRU FM840-T)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

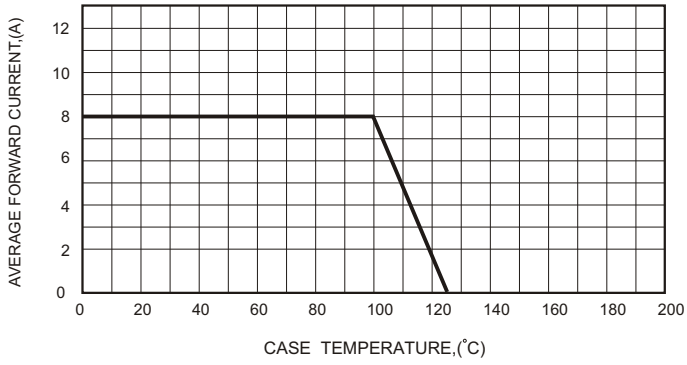


FIG.2-TYPICAL FORWARD CHARACTERISTICS

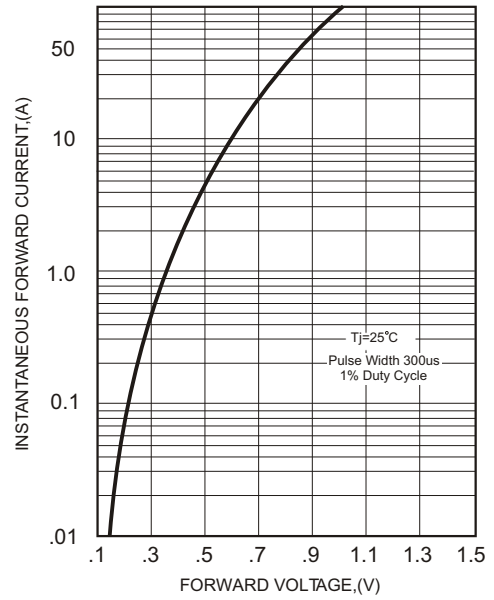


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

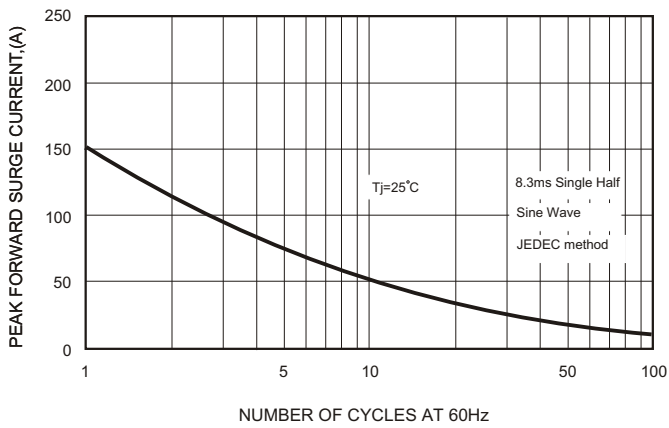


FIG.5 - TYPICAL REVERSE CHARACTERISTICS

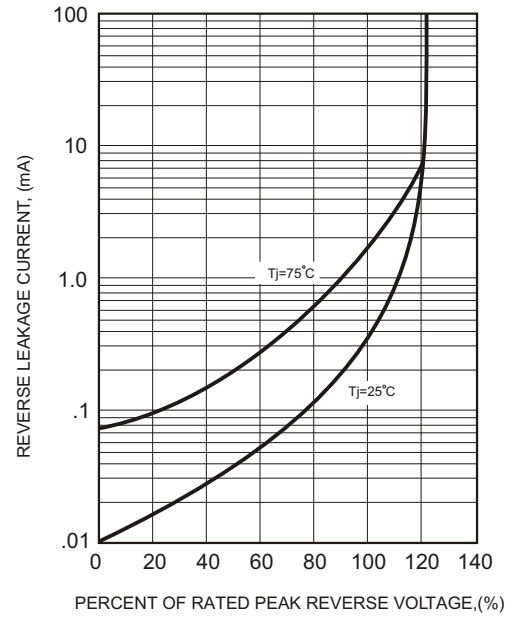


FIG.4-TYPICAL JUNCTION CAPACITANCE

